

# 8A, 400V - 1000V Surface Mount Rectifier

#### **FEATURES**

- AEC-Q101 qualified
- Glass passivated chip junction
- Low forward voltage drop
- Ideal for automated placement
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- DC to DC converter
- Automotive application
- Car lighting
- Snubber
- · General purpose

#### **MECHANICAL DATA**

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.270g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I <sub>F</sub>	8	Α	
$V_{RRM}$	400 - 1000	V	
I <sub>FSM</sub>	200	Α	
$T_{JMAX}$	150 °C		
Package	DO-214AB (SMC)		
Configuration	Single die		









**DO-214AB (SMC)** 



ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)							
PARAMETER		SYMBOL	S8GCH	S8JCH	S8KCH	S8MCH	UNIT
Marking code on the device			S8GC	S8JC	S8KC	S8MC	
Repetitive peak reverse voltage		$V_{RRM}$	400	600	800	1000	V
Reverse voltage, total rms value		V <sub>R(RMS)</sub>	280	420	560	700	V
Forward current		I <sub>F</sub>	8			Α	
Surge peak forward current, 8.3ms single half sine-wave superimposed on rated load	$T_J = 25^{\circ}C$	1	200			Α	
	$T_J = 125$ °C	I <sub>FSM</sub>	170				Α
Surge peak forward current, 1.0ms				00		Α	
single half sine-wave superimposed on rated load	$T_J = 125^{\circ}C$	I <sub>FSM</sub>	338			Α	
Junction temperature		TJ	- 55 to +150		°C		
Storage temperature		T <sub>STG</sub>	- 55 to +150			°C	



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THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-lead thermal resistance	$R_{\Theta JL}$	12.5	°C/W	
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	44.0	°C/W	

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage <sup>(1)</sup>	I <sub>F</sub> = 8A, T <sub>J</sub> = 25°C	V <sub>F</sub>	-	0.985	V
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>	T <sub>J</sub> = 25°C		-	10	μA
Reverse current @ rated V <sub>R</sub>	T <sub>J</sub> = 125°C	– I <sub>R</sub>	-	250	μA
Junction capacitance	1MHz, $V_R = 4.0V$	CJ	48	-	pF

#### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING		
S8xCH	DO-214AB (SMC)	3,000 / Tape & Reel		

#### Notes:

1. "x" defines voltage from 400V(S8GCH) to 1000V(S8MCH)



#### **CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

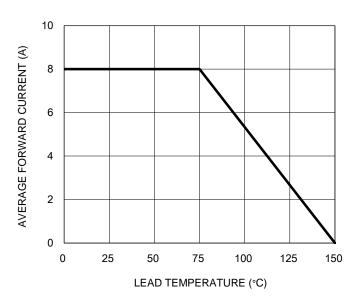


Fig.2 Maximum Non-repetitive Forward Surge Current

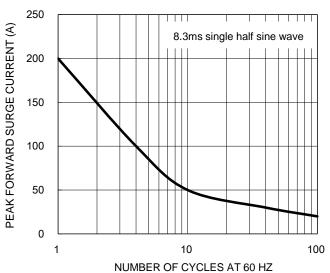


Fig.3 Typical Reverse Characteristics

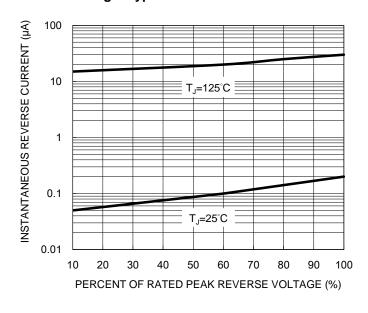
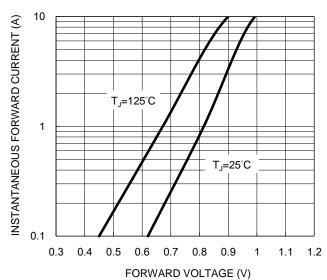


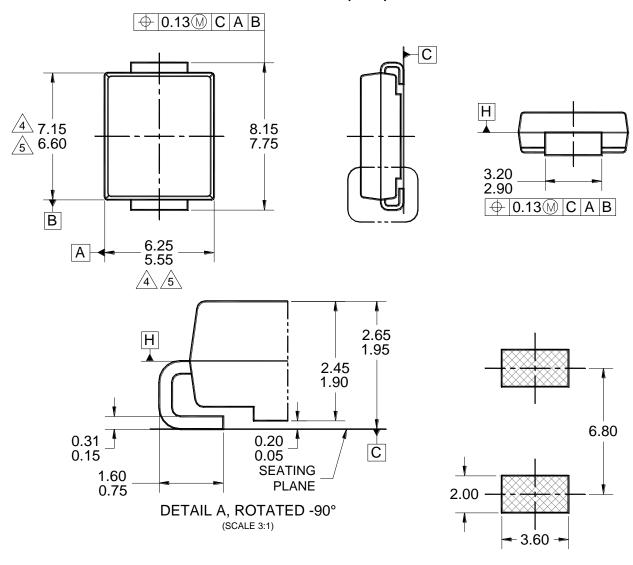
Fig.4 Typical Forward Characteristics

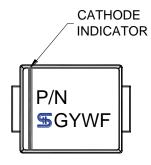




#### **PACKAGE OUTLINE DIMENSIONS**

#### **DO-214AB (SMC)**





#### MARKING DIAGRAM

P/N = MARKING CODE

= GREEN COMPOUND

YW = DATE CODE

= FACTORY CODE

#### NOTES: UNLESS OTHERWISE SPECIFIED

1. ALL DIMENSIONS ARE IN MILLIMETERS.

SUGGESTED PAD LAYOUT

- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC DO-214, VARIATION AB, ISSUE D.
- MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
- MOLDED PLASTIC BODY LATERAL DIMENSIONS TO BE DETERMINED AT DATUM PLANE H.
  - 6. DWG NO. REF: HQ2SD07-DO214SMC-036 REV A.



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